

Surface Mount Ultrafast Plastic Rectifier


DO-214AC (SMA)

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- Ultrafast recovery times for high efficiency
- Low forward voltage, low power losses
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.0 A
V_{RRM}	50 V, 100 V, 150 V, 200 V
I_{FSM}	30 A
t_{rr}	15 ns
V_F at I_F	0.92 V
T_J max.	150 °C
Package	DO-214AC (SMA)
Diode variations	Single die

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS-compliant, commercial grade

Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified ("X" denotes revision code e.g. A, B,)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 2 whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	ES1A	ES1B	ES1C	ES1D	UNIT
Device marking code		EA	EB	EC	ED	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	V
Maximum DC blocking voltage	V_{DC}	50	100	150	200	V
Maximum average forward rectified current (fig. 1)	$I_{F(AV)}$	1.0				A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	30				A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150				°C



ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Maximum instantaneous forward voltage	$I_F = 0.6\text{ A}$	$V_F^{(1)}$	0.865	V	
	$I_F = 1.0\text{ A}$	V_F	0.920		
Maximum DC reverse current at rated DC blocking voltage		I_R	$T_A = 25\text{ }^\circ\text{C}$	5.0	μA
			$T_A = 100\text{ }^\circ\text{C}$	100	
Maximum reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$	t_{rr}	15	ns	
Maximum reverse recovery time	$I_F = 0.6\text{ A}, V_R = 30\text{ V}, dI/dt = 50\text{ A}/\mu\text{s}, I_{rr} = 10\% I_{RM}$	t_{rr}	$T_J = 25\text{ }^\circ\text{C}$	25	ns
			$T_J = 100\text{ }^\circ\text{C}$	35	
Maximum stored charge	$I_F = 0.6\text{ A}, V_R = 30\text{ V}, dI/dt = 50\text{ A}/\mu\text{s}, I_{rr} = 10\% I_{RM}$	Q_{rr}	$T_J = 25\text{ }^\circ\text{C}$	10	nC
			$T_J = 100\text{ }^\circ\text{C}$	25	
Typical junction capacitance	4.0 V, 1 MHz	C_J	10	pF	

Note(1) Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	ES1A	ES1B	ES1C	ES1D	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	85				$^\circ\text{C}/\text{W}$
	$R_{\theta JL}^{(1)}$	35				

Note

(1) Units mounted on PCB 5.0 mm x 5.0 mm (0.013 mm thick) land areas

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
ES1D-E3/61T	0.064	61T	1800	7" diameter plastic tape and reel
ES1D-E3/5AT	0.064	5AT	7500	13" diameter plastic tape and reel
ES1DHE3_A/H ⁽¹⁾	0.064	H	1800	7" diameter plastic tape and reel
ES1DHE3_A/I ⁽¹⁾	0.064	I	7500	13" diameter plastic tape and reel

Note

(1) AEC_Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

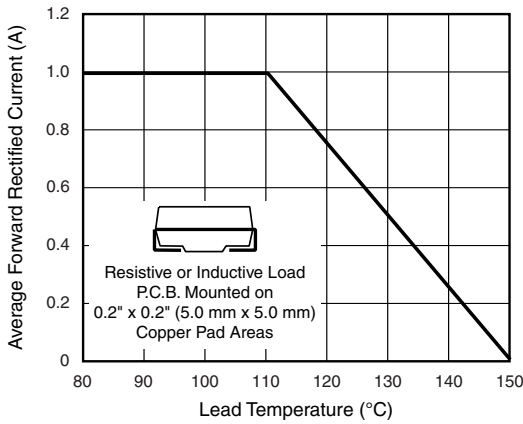


Fig. 1 - Maximum Forward Current Derating Curve

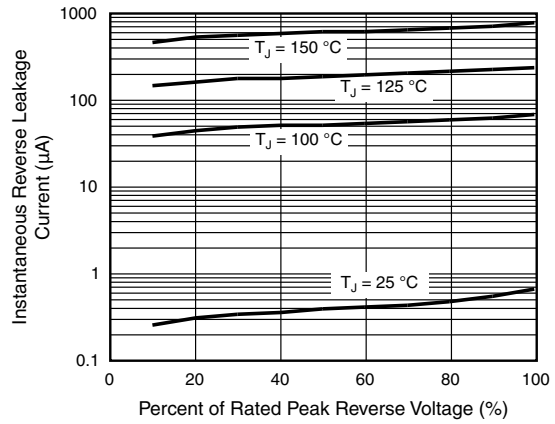


Fig. 4 - Typical Reverse Leakage Characteristics

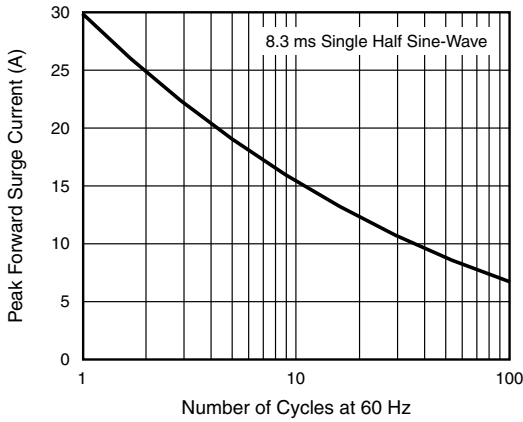


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

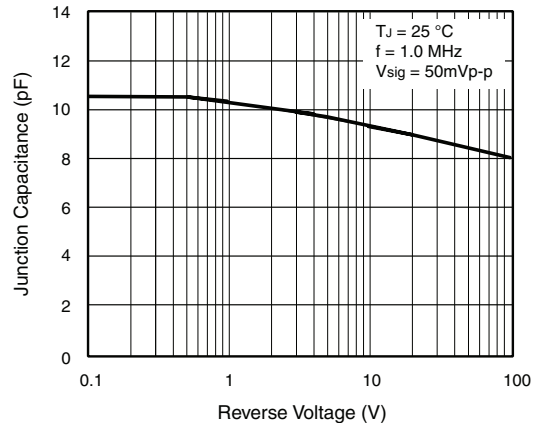


Fig. 5 - Typical Junction Capacitance

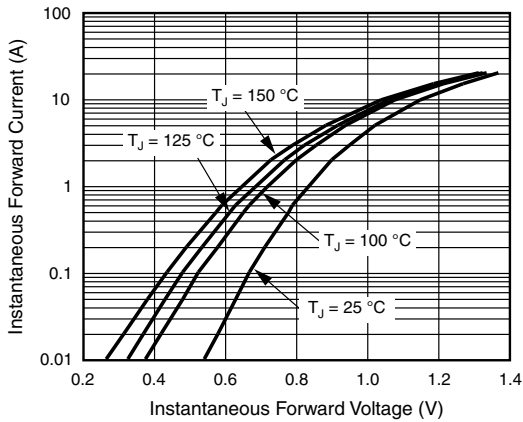


Fig. 3 - Typical Instantaneous Forward Characteristics

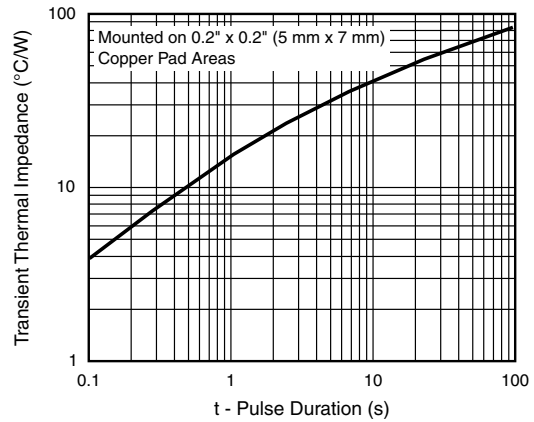
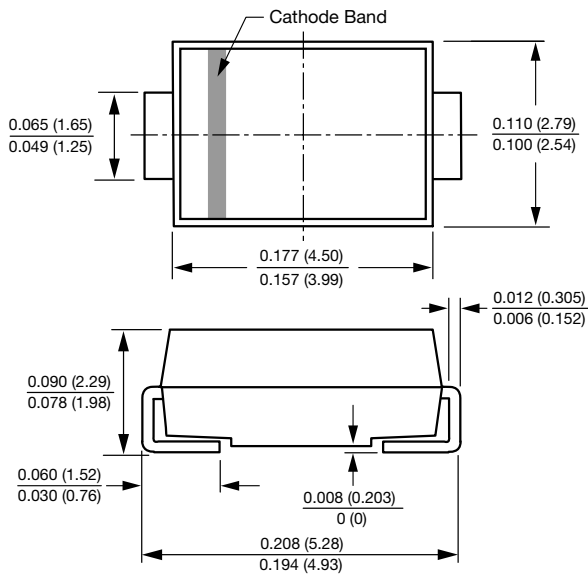


Fig. 6 - Typical Thermal Impedance

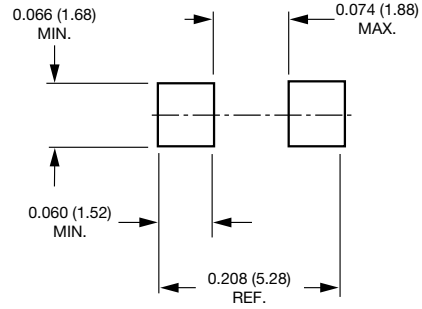


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout





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